

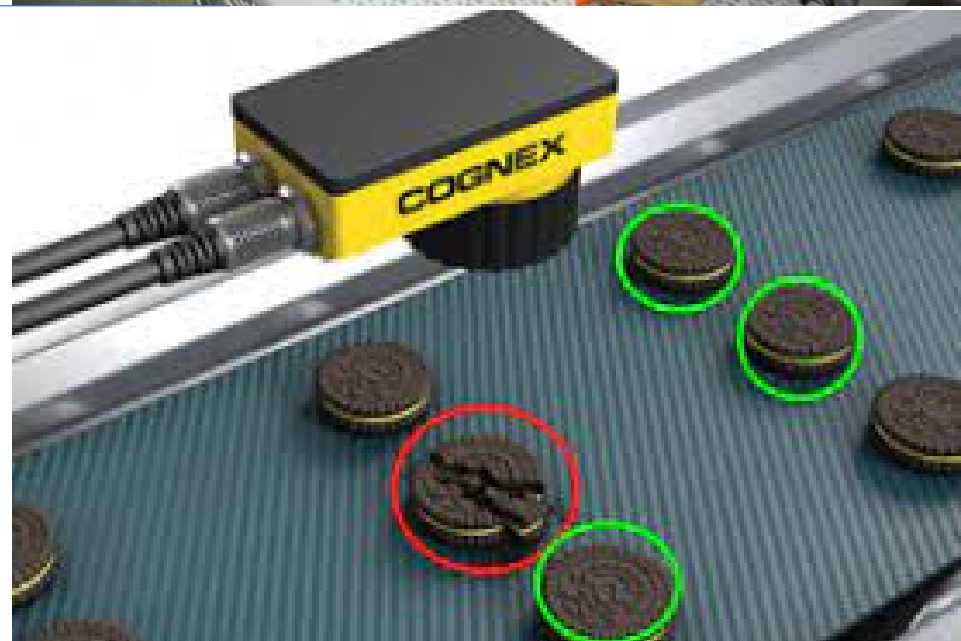
***JHCTECH***

Accurate Capture

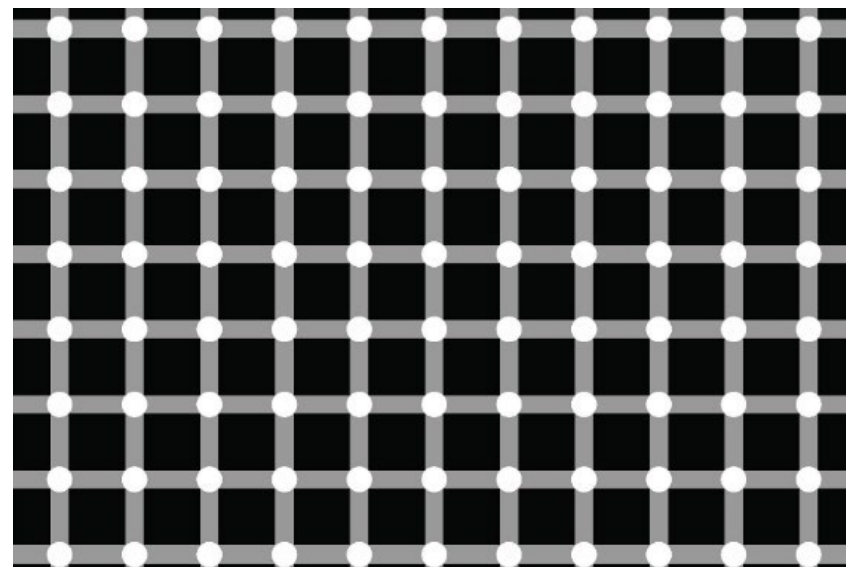
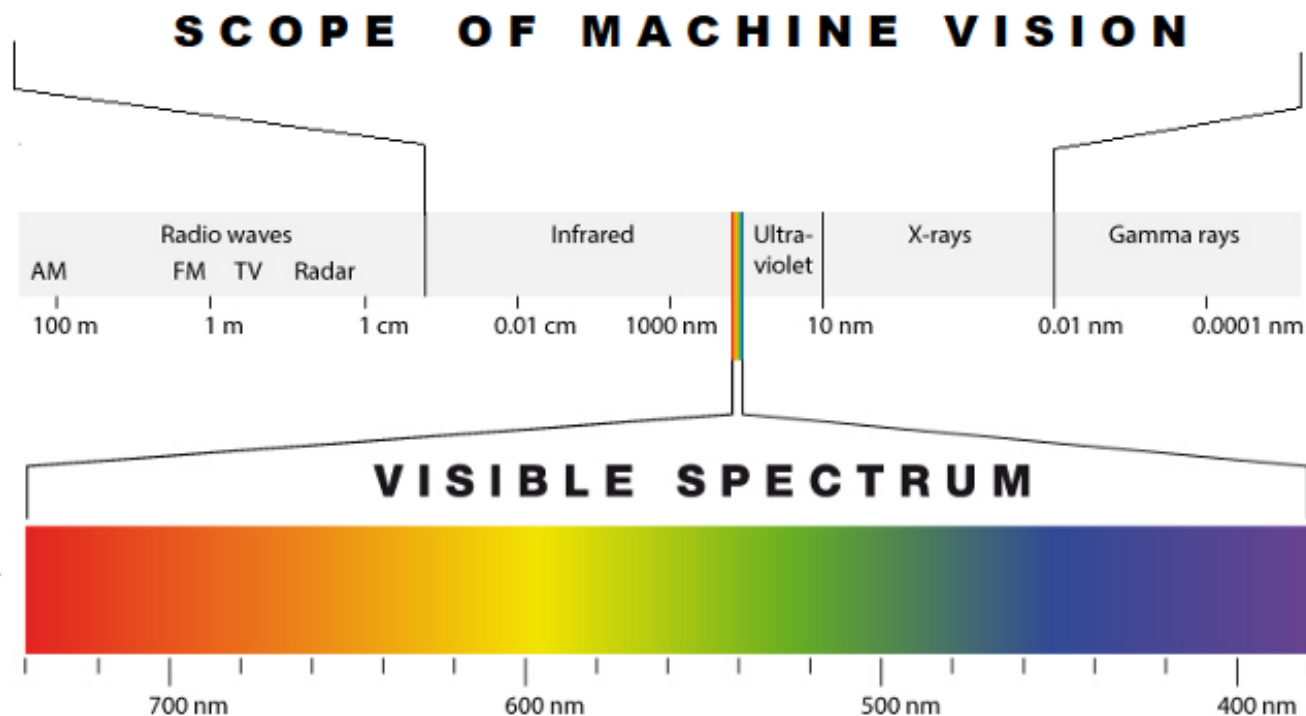
-- AI-based Automation of Appearance Defect --

1

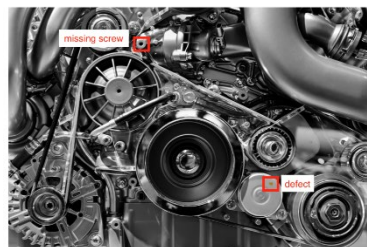
Automatic Visual Inspection



Automated Visual Inspection



Automated Visual Inspection

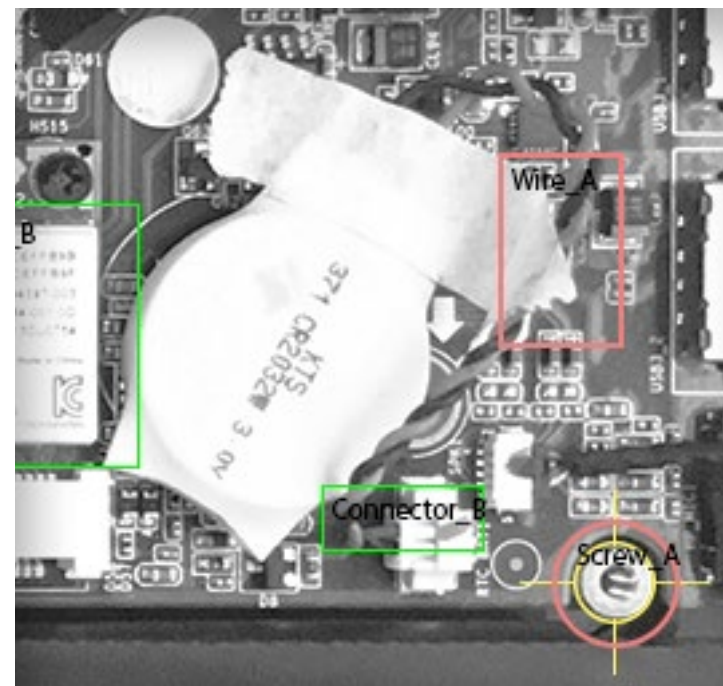


Inspect automobile parts for defects



Identify defective products on your assembly line

 Automobile parts Targets Material parts Resin parts Fabric Defects Scratch Crack Dirt Dent Burr / Chip	 Electronic parts PCB Electronic parts Electrical component Panel Defects Scratch Crack Burr / Chip	 Building materials Wood board Sash Metal fitting Tile Defects Scratch Crack Dirt Dent Surface Pattern	 Nonferrous metals Wire, Cable Aluminum Stainless Steel Defects Scratch Crack Dirt Dent
 Raw materials Chemical fiber Rubber Glass Paper, Pulp Defects Scratch Crack Dirt Dent	 Food Processed Food Beverage Defects Foreign object Wrong print Leak	 Medical Medicine Defects Foreign object Wrong print Crack	 Others Material parts Resin parts Defects Defect classification Shape check



Automated Visual Inspection

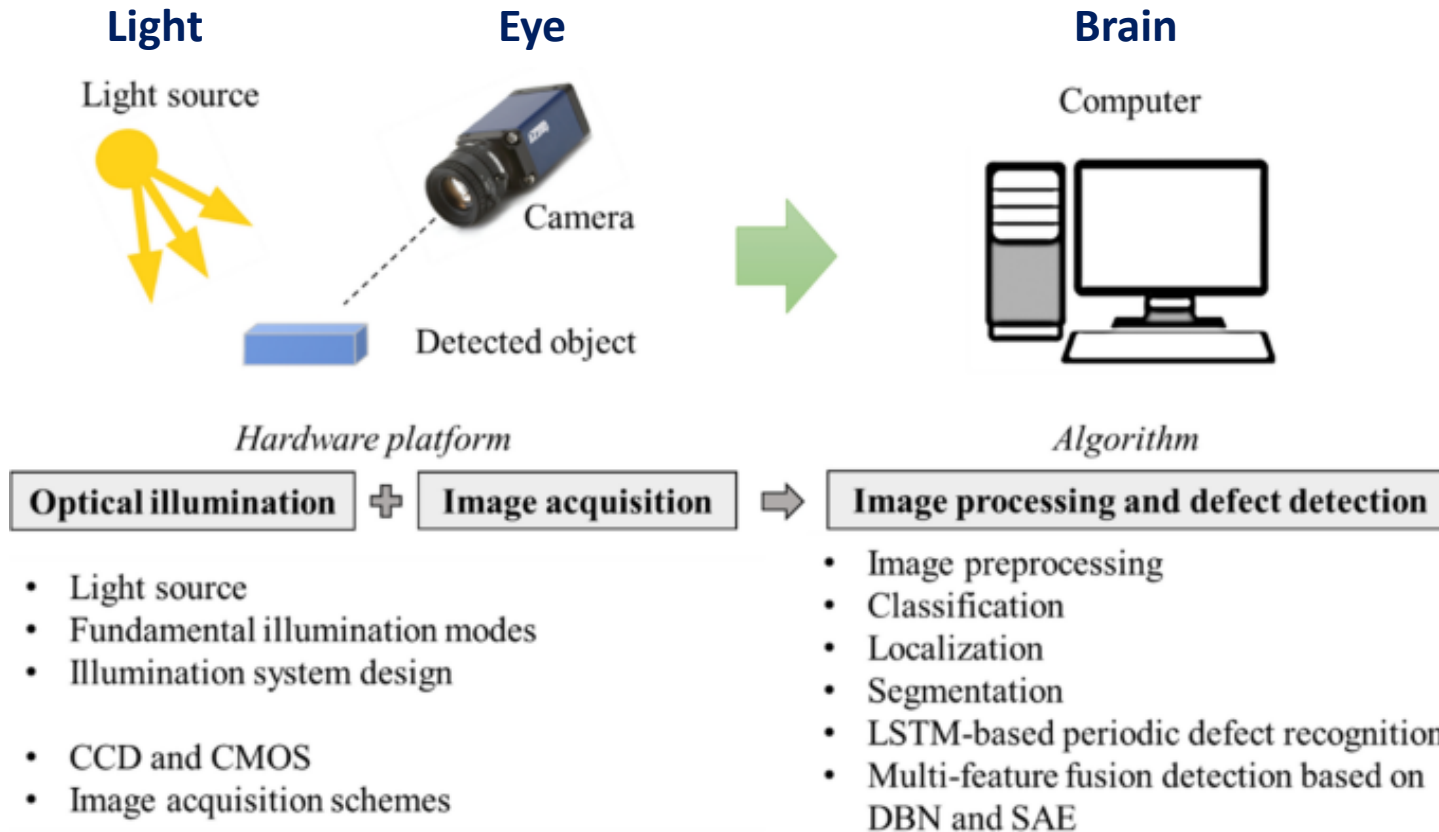


Image recognition techniques for visual inspection and fault detection leads to productivity of + **50%**

AI based visual inspection – defect recognition by up **to 90%** as compared to human detection

Automated Visual Inspection

Digitalisation

- Sensors
- Storage
- Communication
- **Processing**

Automation

- Process Automation
- Automation Optimisation
- Self-Learning and Self-Diagnostics / Machine Learning
- Real AI (no human reliance) algorithms

JHCTECH AI Ready Embedded Computing Solutions

Autonomy

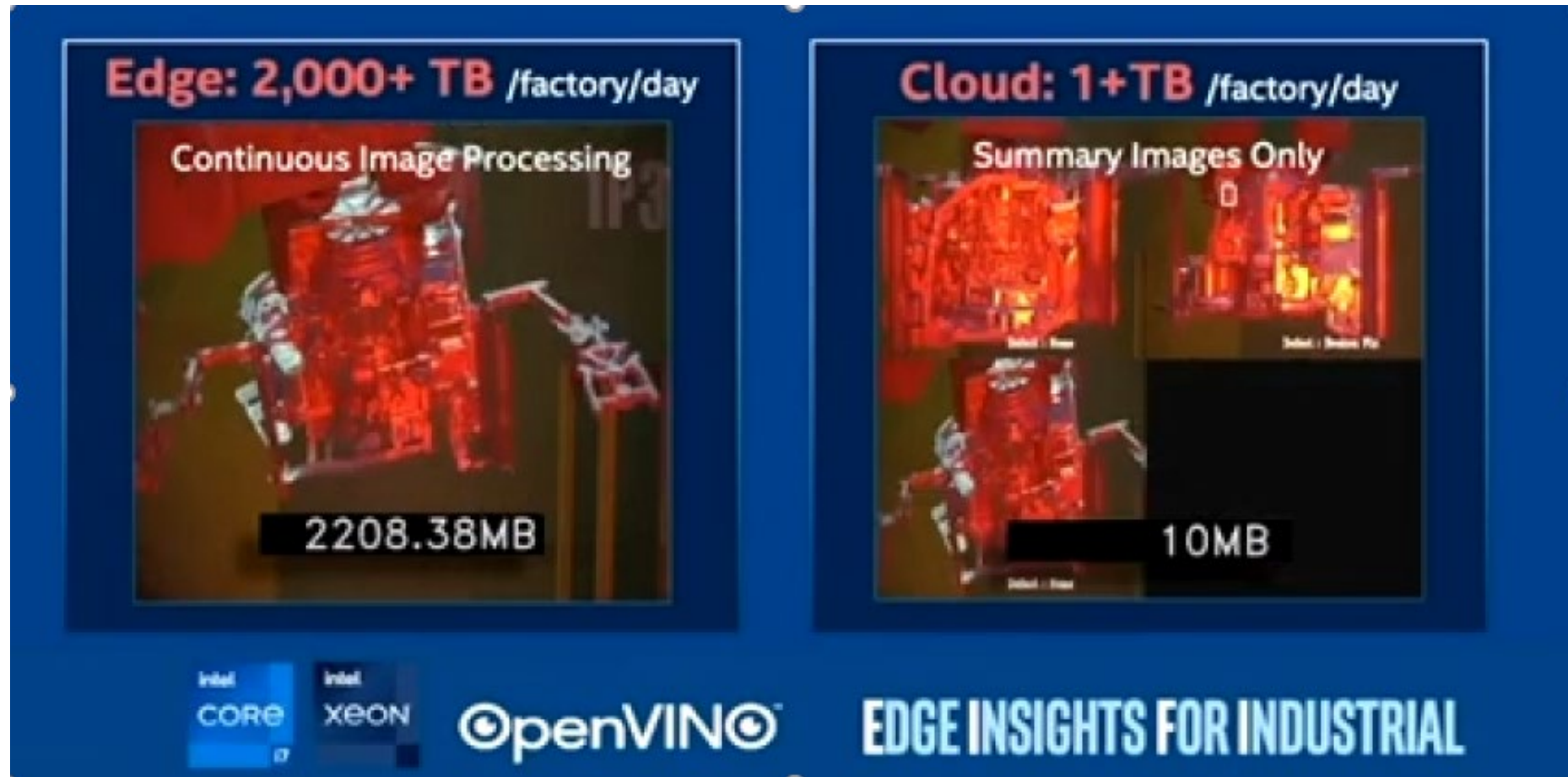
Control

Computing

Connectivity

Embedded Computing

Intel Direction

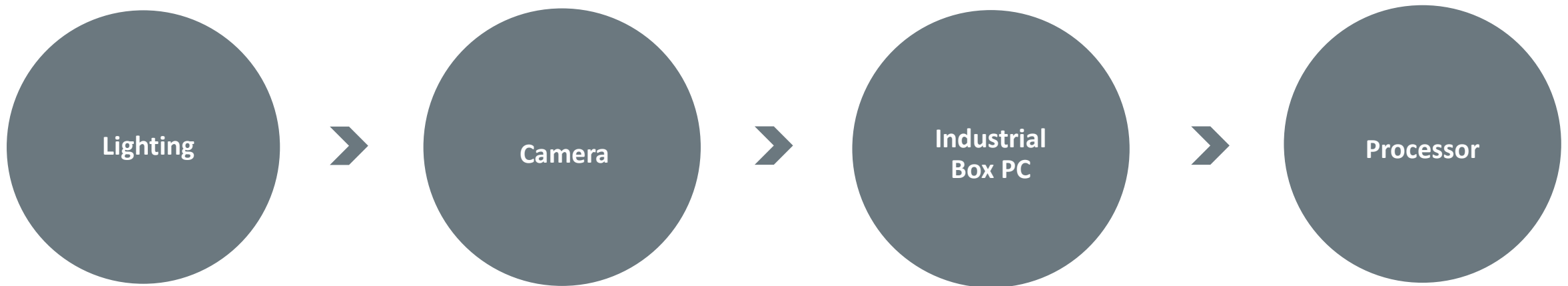


2

JHCTECH Solutions for Appearance Defect Inspection

Components of an automatic inspection system

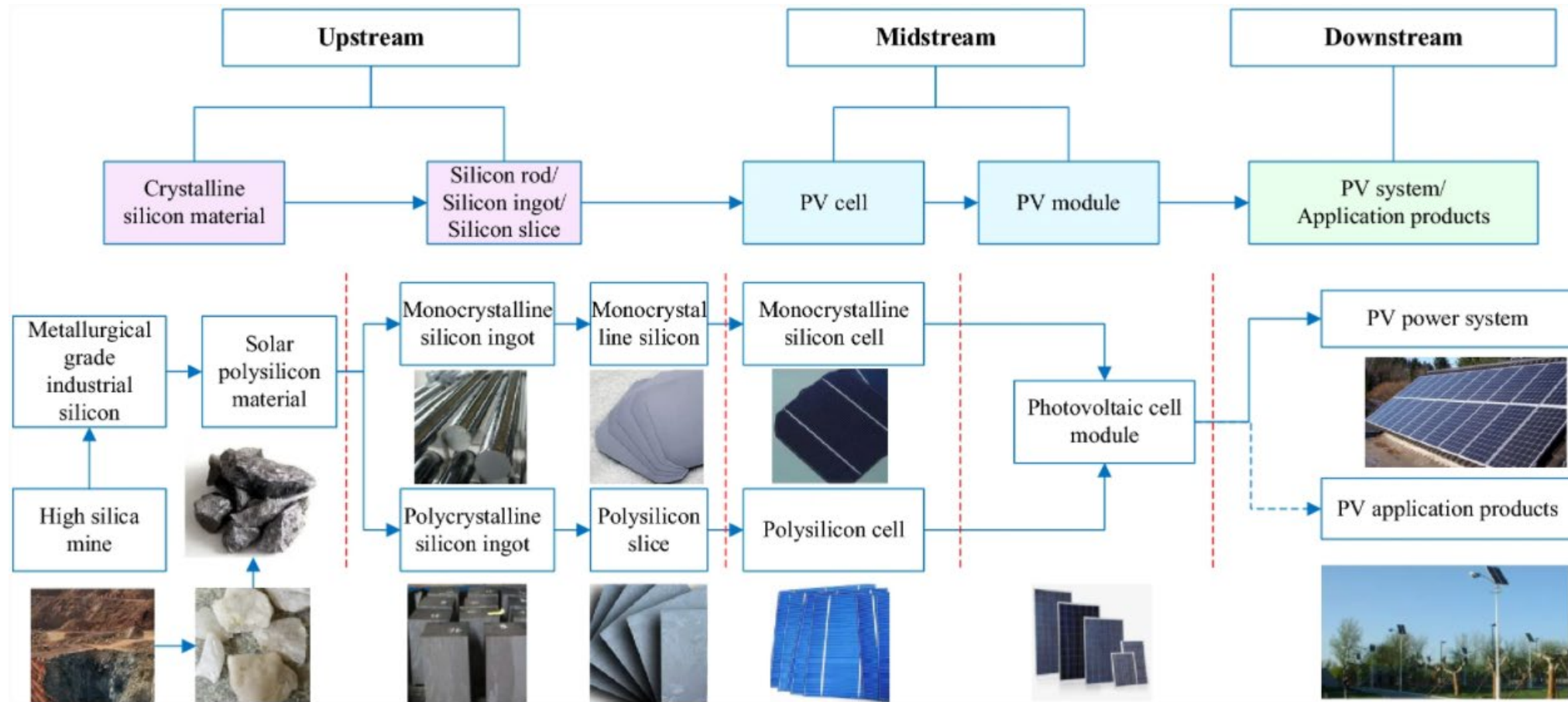
The components of an automatic inspection system usually include lighting, a camera or other image acquiring device, a processor, software, and output devices.



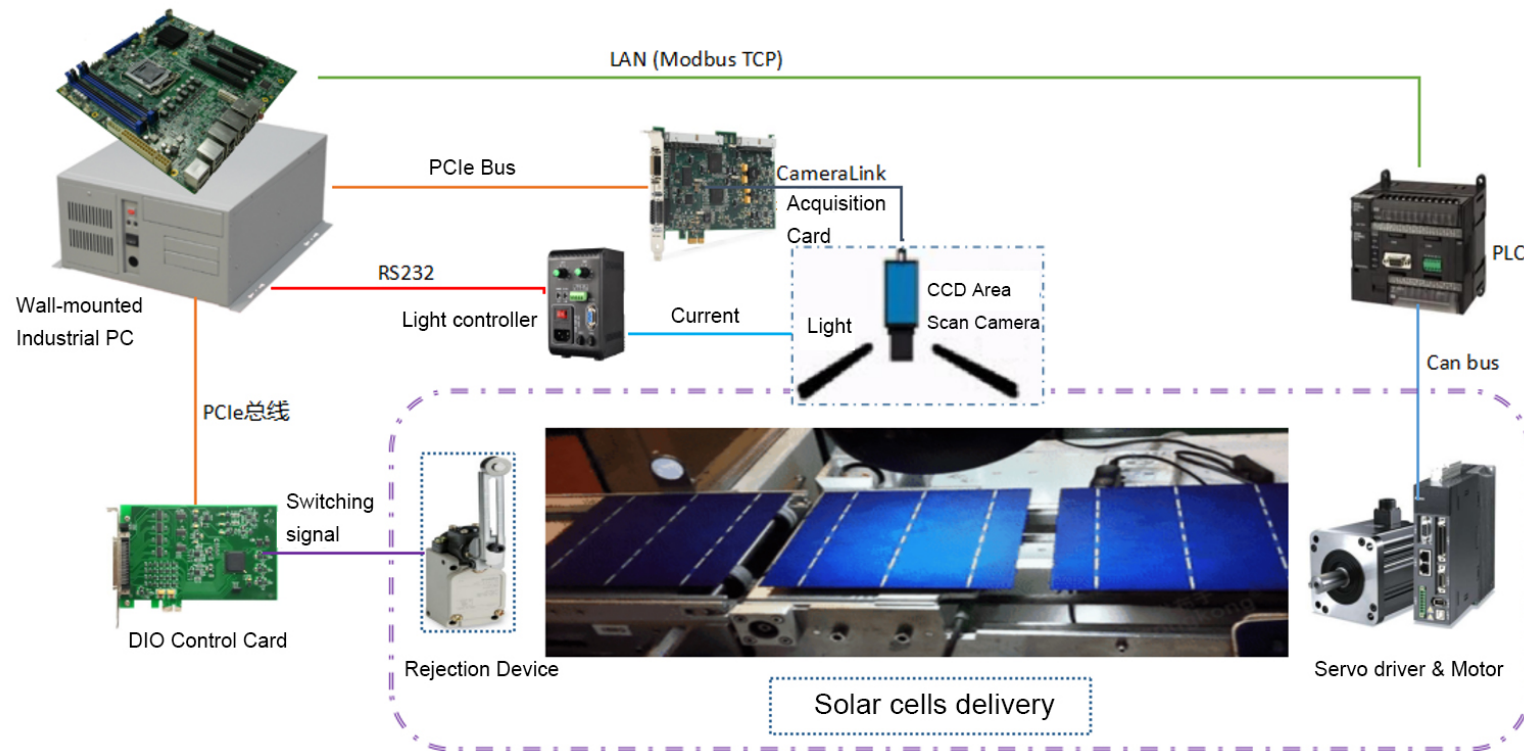
Defect Inspection in Solar Cells



Solar Industry Chain



The flow diagram of PV industry-chain



The Basic Visual Inspection System includes:

- Main Controller X86 Industrial PC;
- CameraLink video capture card
- DIO control card
- Optical Acquisition Sensor—Array CCD camera
- Light Controller;
- PLC, Servo drive and motor;
- Rejection Device
- Smart Vision System Software

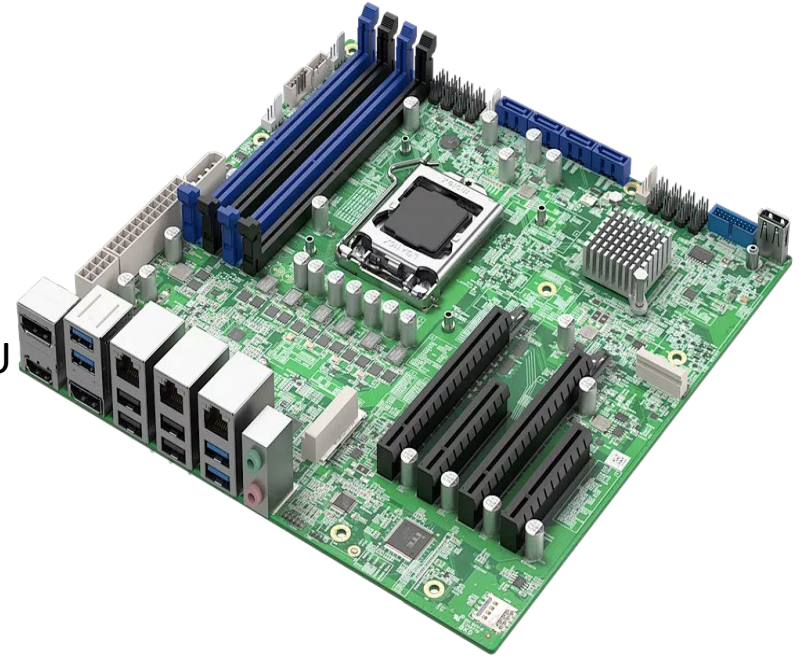
Defect Inspection of Solar cells-Hardware Architecture

Why we need x86?

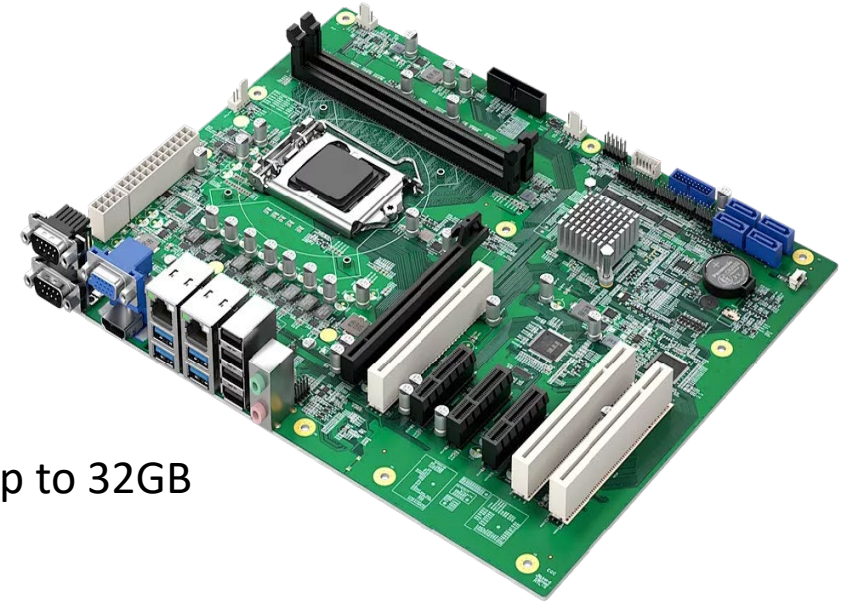
- The maximum configuration of 65 million pixel array industrial camera, accuracy up to 0.04mm /pixel;
- Achieve 2mm edge damage, can detect 1*1mm surface holes or foreign body defects;
- Identify scratches with a length of more than 2mm, and detect fault grids with a length of more than 1mm;
- Open platform: Intel mature X86 architecture +Windows10 open operating system;
- **Powerful computing power: Intel Coffee Lake or Cometlake Core I3/I5/I7/I9 CPU**, up to 8 cores and 16 threads, up to 5.0ghz overclocked version processor;
- Engineering software architecture: general vision platform software, **customizable GUI**;
- Visual tool library compatible: VisionPro, Halcon, OpenCV and other visual tool library;
- **Compatible with a variety of 2D/3D camera brands**: support LMI, SmartRay, Cognex, Keyence, SICK, PhotoNeo, etc., convenient for users to select the camera;
- **PLC communication**: integrated with a variety of PLC communication protocols, registers can be accessed in the form of Siemens, Mitsubishi, Omron and other brands PLC communication, more compatible with different transmission line servo control;
- Robot communication and guidance: **integrated TCP/IP protocol**, can directly communicate with ABB, Kuka, Yaskawa and other robots, can realize the visual positioning of the Robot arm application expansion;
- Project management and interactive interface: integrated parameter setting, data storage and management, data analysis, report output, record storage and analysis, etc., friendly and convenient operation interface

JHCTECH MATX-I961 Advantages

- Intel® Xeon® E or 9th/8th-Gen Core™ I9 / i7 / i5 / i3 / Pentium, Celeron CPU
- Intel® Q370 / C246 Chipset
- 4 x DDR4 2666 MHZ or 2400MHz dimms with a maximum of 128GB
- 2*DP, 1*HDMI, support 3 independent 4K display
- 3*LAN, 6*USB3.1 Gen2, 7*USB2.0, 4*COM
- 1 x PCIeX16 or 2 x PCIeX8+2 x PCIeX4 High bandwidth multi-slot expansion
- 1 x Mini PCIe with a SIM card slot and supports WIFI/GPS/GSM/BT
- 4 x SATA3.0 supports RAID0, 1, 5, 10, and 1 x m. 2 2280 m-key (PCIe X4) NVME high-speed storage
- Supports TPM 2.0 security encryption, AMT12.0, Intel® Vpro technology
- Standard 24Pin ATX+8Pin 12V ATX power supply design

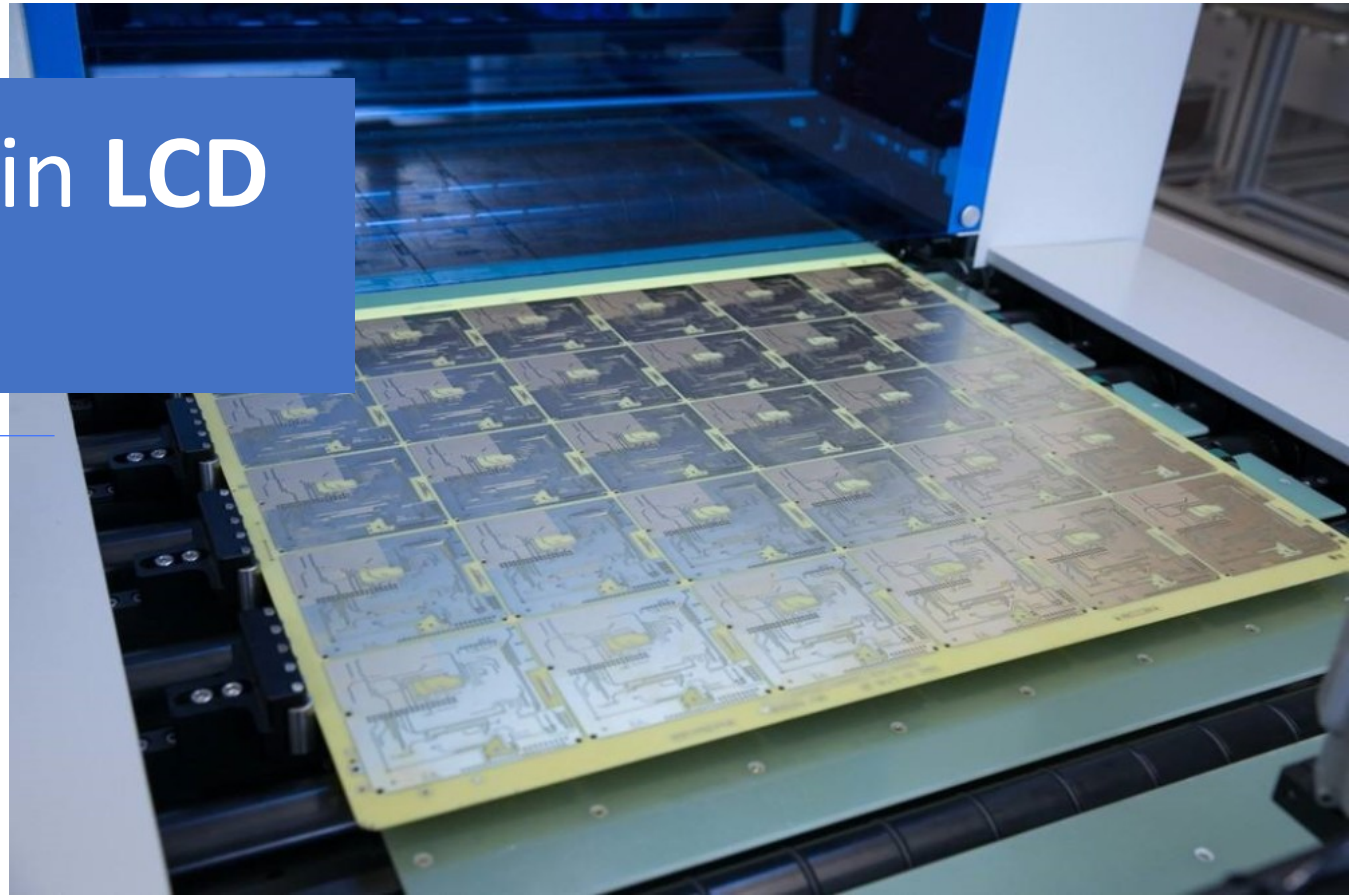


JHCTECH ATX-I971 Advantages

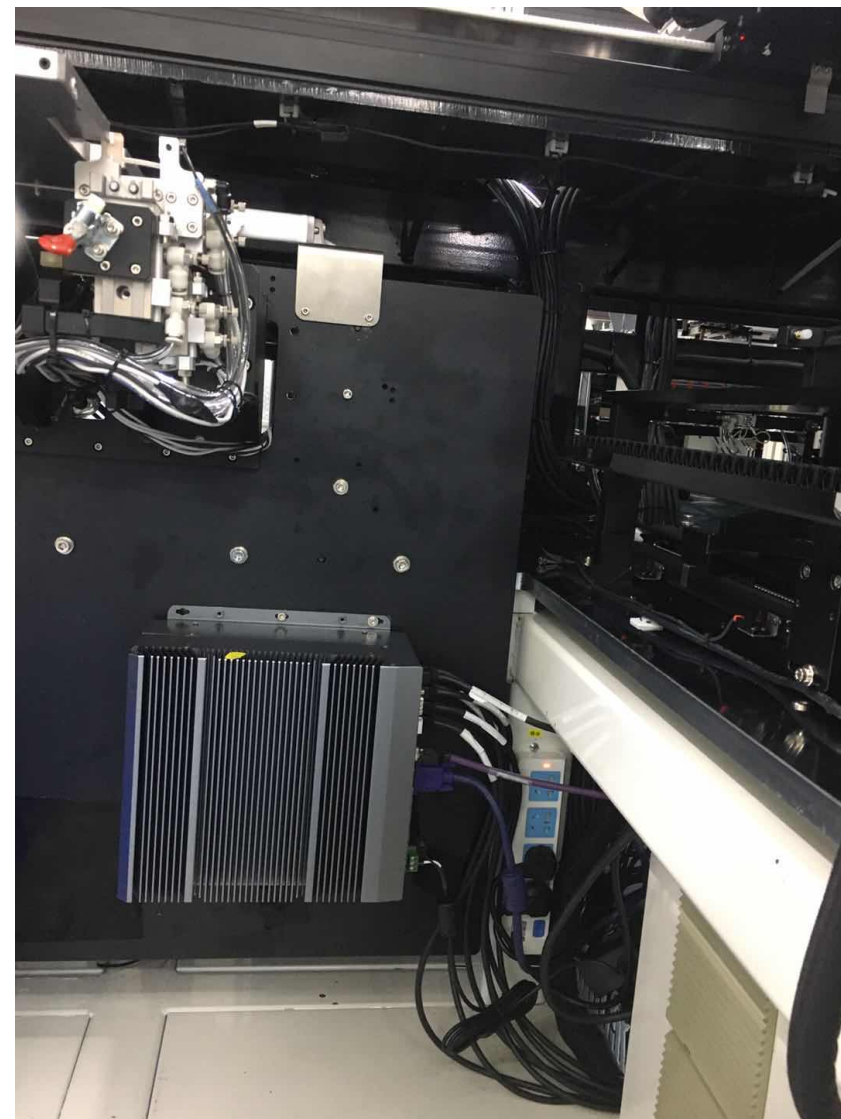
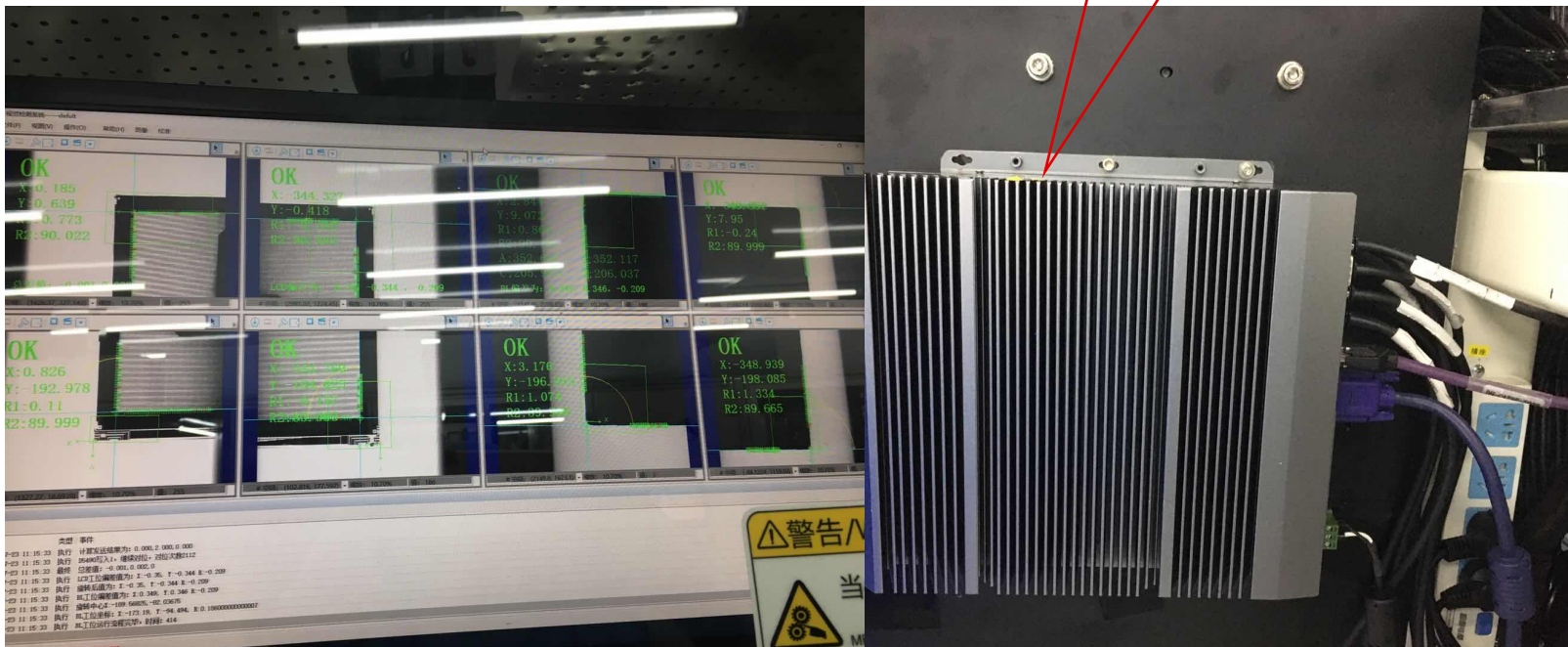


- Intel 10th Gen. Cometlake-S Core™ i9/i7/i5/i3/Pentium/Celeron CPU
- Intel H420E Chipset
- Dual-channel 2 x DDR4 2933MHz dual in-line memory modules (dimms), up to 32GB
- Intel UHD Graphic core display, 1 x VGA and 1 x HDMI dual display
- 1*I219LM gigabit network port and 1*I225V chip 2.5G network port
- 6*USB3.0, 4*USB2.0, 6*COM, 8bit DIO
- 1*PCIeX16, 3*PCI, 3*PCIeX4(X1 signal) a total of 7 expansions, can be flexibly set through the BIOS into a PCIeX4 expansion slot
- 4*SATA3.0 6.0Gbps, optional audio, optional TPM2.0
- The standard 24-pin ATX + 8-pin 12V ATX power supply design supports a maximum of 120W CPU power supply
- Standard ATX hole size, fully adapted to the market frame and wall - mounted chassis

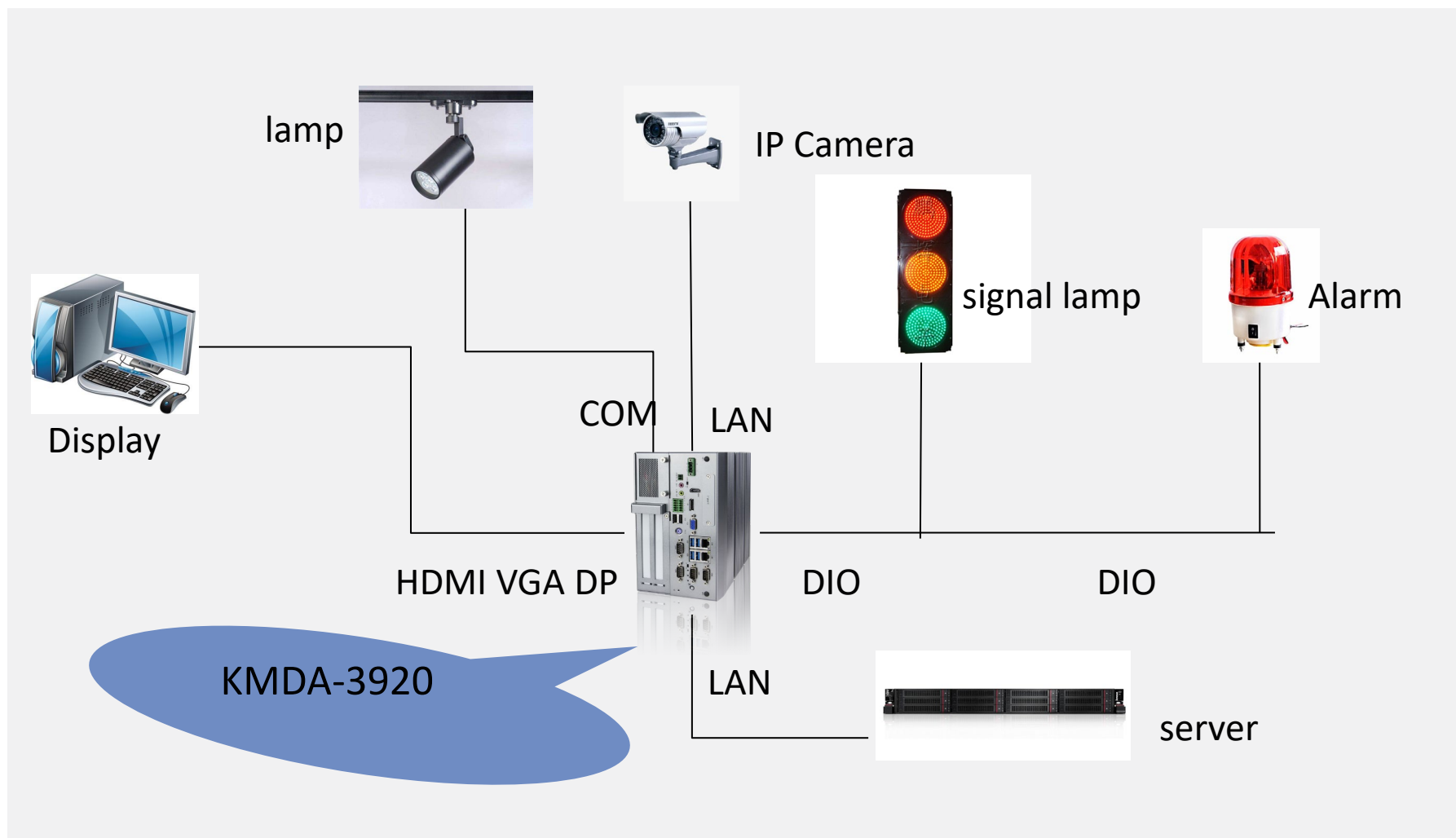
Defect Inspection in LCD Panel Surface



KMDA-3920

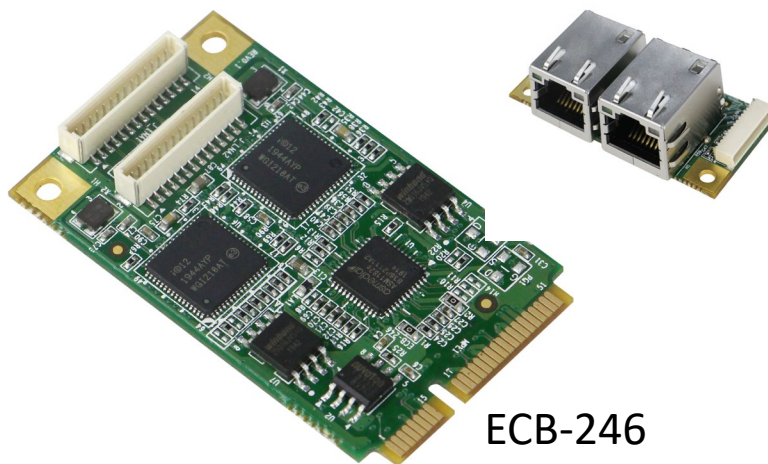


► Topography





KMDA-3920



ECB-246



BRAV-7302



KMDA-3202

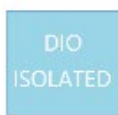
KMDA-3920



Key Specification

- Chipset H110/Q170
- Intel® Kabylake-S/Skylake-S Core I3/I5/I7 CPU
- 2*DDR4 2400/2133MHz SODIMM, up to 32GB
- DP+HDMI+VGA, Optional 3 independent displays(Q170)
- 2/4*LAN, 4*USB3.0, 3*USB2.0,4*COM,8-bit DIO
- 1*Mini PCIe(Pcie+USB),1*M.2 2242B-Key
- PCIeX16+PCleX4 or 2*PCI expansion
- 1*mSATA, 2*2.5" SATA, support Raid0,1(Q170)
- Support Intel® vPro(Q170)and TPM2.0
- DC 12~24V Wide Power Input
- Desktop Mounting,Wall Mounting

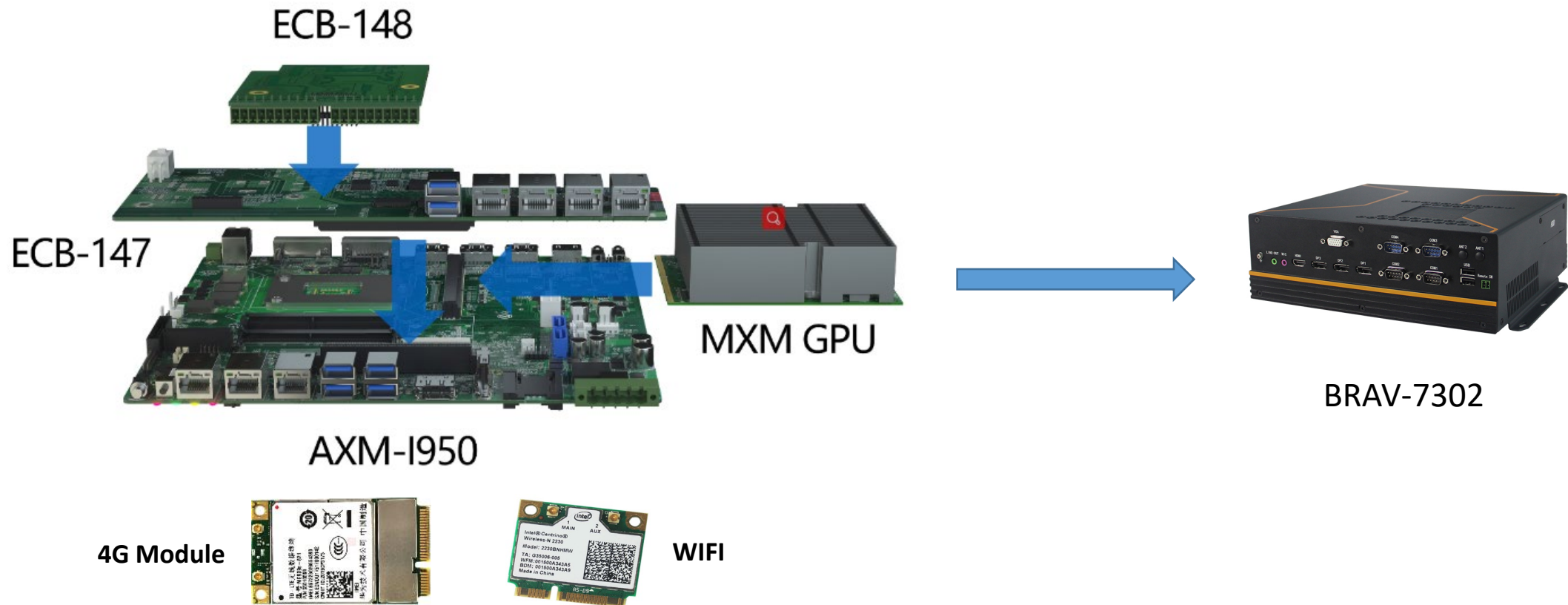
KMDA-3202



Key Specification

- Intel® Skylake-U/Kabylake-UCPU
- 2*DDR4 2133MHz SODIMM, Up to 32GB
- 1*DP, 1*HDMI, Dual 4K display
- 3*Gig LAN, 4*POE, 4*USB3.0, 5*USB2.0(one inside)
- 6*COM, 1*PS/2, 16bit Iso. DIO, 8bit DIO, Audio out/Mic
- 1*F-Mini PCIe(Pcie+USB),1*M.2 2242 B-Key
- 1*F-mSATA, 1*2.5" SATA HDD/SSD driver bay
- Support Intel iVpro and TPM2.0
- DC 9~30V Wide Power Input
- Desktop Mounting

Skylake/Kabylake-S+MXM GPU(1050Ti,1060,1070)



BRAV 7302



Key Specification

- CPU and GPU fan cooling, independent air passage
- Intel® Kabylake-S/Skylake-S Core I3/I5/I7 CPU
- 2400/2133MHz SODIMM, Up to 32GB
- 1*MXM 3.1 socket, support NVIDIA/AMD GPU Intel
- 1*DP+1*HDMI+1*VGA, GPU 3*DP+1*HDMI
- 3/7*LAN, 6*USB3.0, 3*USB2.0, 4*COM,16DIO,Audio
- 1*Mini PCIe(PCle+USB),1*M.2 2242 B-Key
- 1*mSATA, 1/2*2.5" SATA, support Raid0,1 Support Intel®
- iVpro and TPM2.0
- DC 6~48V Wide Power Input



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